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APPROVAL SHEET

Part No: **BAG323AA-ZVD-3000mA**

NOTE : Green Part

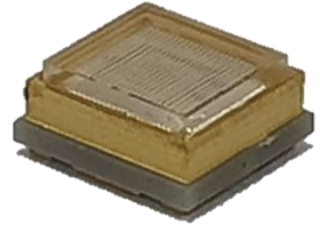
MAKER			CUSTOMER	
				
R&D	QA	Sales	Checked	Approved
				

Prepared	Checked	Approved
Rachel Lee	Sky Lin	Kenneth Wu

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VCSEL 3235 940nm 2W

Datasheet



Features:

- Vertical Cavity Surface Emitting Laser (VCSEL) Technology
- Various Rectangle Emitting Light Pattern
- Compact Package Size: 3.2×3.5×1.45mm
- Narrow spectral width (<4 nm typ.)
- High Power Applications
- Photodiode Detection Mechanism
- High Reliability

Typical Applications:

- 3D TOF Applications
- Gesture
- Distance Detection
- Infrared Uniform Lighting

Optical and Electrical Characteristics (at room temperature, $T_a=25^{\circ}\text{C}$)

Parameter	Symbol	Operating Condition	Value			Units
			Min.	Typ.	Max.	
Output power	P_o	$I_F=3.0\text{A}$, $t_p=500\mu\text{s}$	1800	2250	2800	mW
Threshold current	I_{th}	-	-	500	-	mA
Forward voltage	V_F	$I_F=3.0\text{A}$, $t_p=500\mu\text{s}$	1.80	2.00	2.20	V
Slope efficiency	η_s	$I_F=3.0\text{A}$, $t_p=500\mu\text{s}$	0.75	0.85	-	W/A
Power conversion efficiency	PCE	$I_F=3.0\text{A}$, $t_p=500\mu\text{s}$	34	37	40	%
Center wavelength	λ_c	$I_F=3.0\text{A}$, $t_p=500\mu\text{s}$	930	940	950	nm
Spectral width (FWHM)	-	$I_F=3.0\text{A}$, $t_p=500\mu\text{s}$	1	4	6	nm
Chip Via Numbers	-	-	-	544	-	-
PD Forward voltage	V_{FPD}	$I_{FPD}=10\text{mA}$	0.5	-	1.3	V
PD Reverse Breakdown Voltage	V_{BRPD}	$I_{RPD}=100\mu\text{A}$	35	-	-	V
PD Reverse Dark Current	I_D	$V_{RPD}=10\text{V}$	-	2	10	nA
PD Junction Capacitance	C_J	$V_{RPD}=3\text{V}$, $F=1\text{MHZ}$	-	2	10	pF
PD Peak Sensing Wavelength	-	-	-	940	-	nm

Notes:

1. Forward Voltage tolerance is $\pm 0.1\text{ V}$
2. Optical output power tolerance is $\pm 10\%$.
3. The pulse operation was tested on good thermal management with $2.25\text{ cm}^2\text{MCPCB}$.

Temperature-dependent Characteristics

Parameter	Symbol	Operating Condition	Value			Units
			Min.	Typ.	Max.	
Wavelength shift	$\Delta\lambda/\Delta T$	25~100 $^{\circ}\text{C}$	-	0.08	-	nm/ $^{\circ}\text{C}$
Output Power Decay	$\Delta P_o/\Delta T$	25~100 $^{\circ}\text{C}$	-	-0.52	-	%/ $^{\circ}\text{C}$
Forward Voltage Decay	$\Delta V_F/\Delta T$	25~100 $^{\circ}\text{C}$	-	-0.0017	-	V/ $^{\circ}\text{C}$

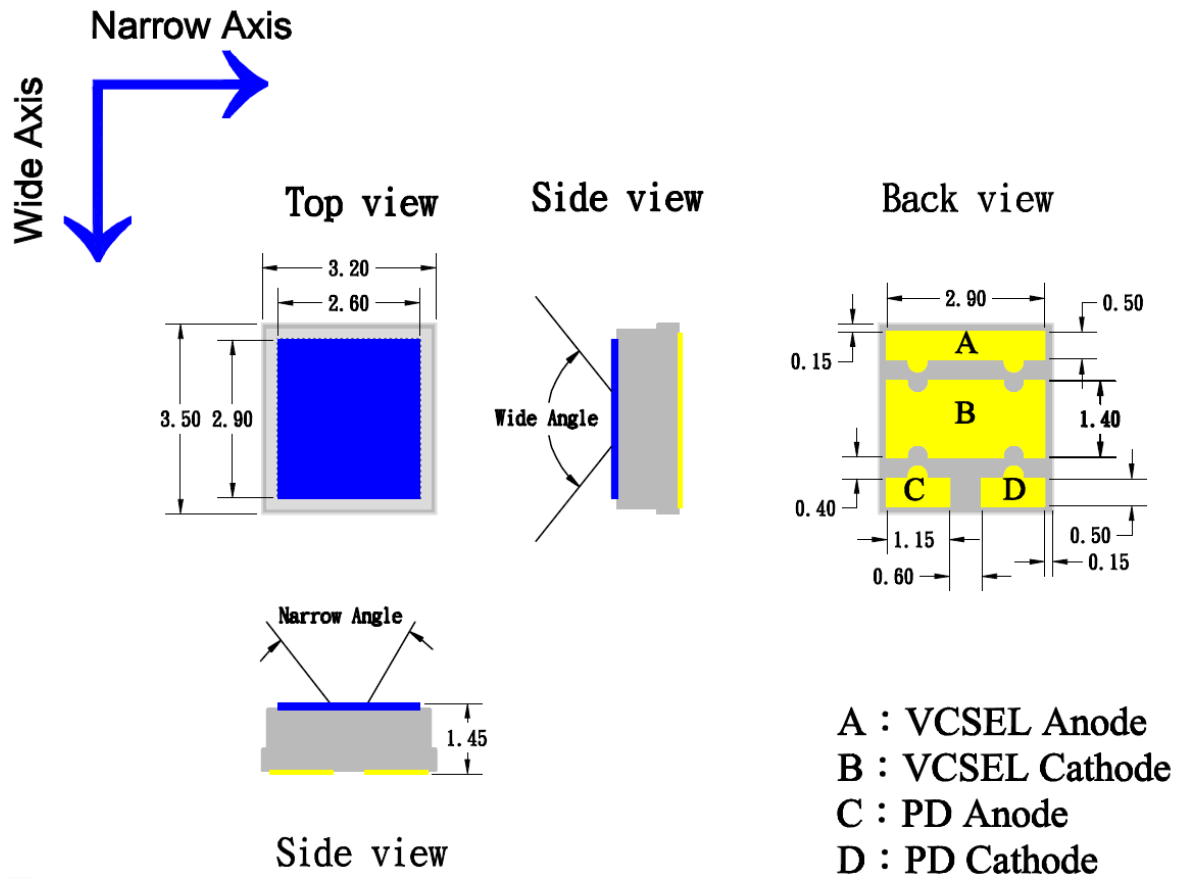


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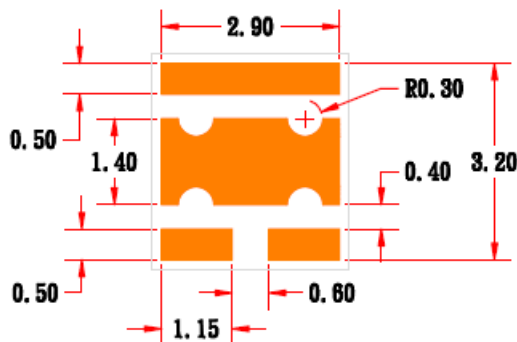
Emitting Angle (Field of View) Categories

Emitting Angle (Rectangle)	Lens Type (Material)	Order Code	Note
60°x45°	MLA (Glass)	BAG323AA-ZVD-3000mA	H=1.45
-	-	-	-
-	-	-	-
-	-	-	-
-	-	-	-
-	-	-	-
-	-	-	-

Mechanical Dimensions



Recommended Soldering Pad:

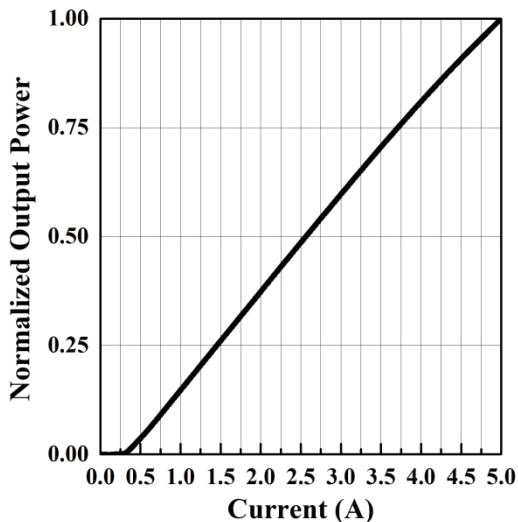


Unit:mm

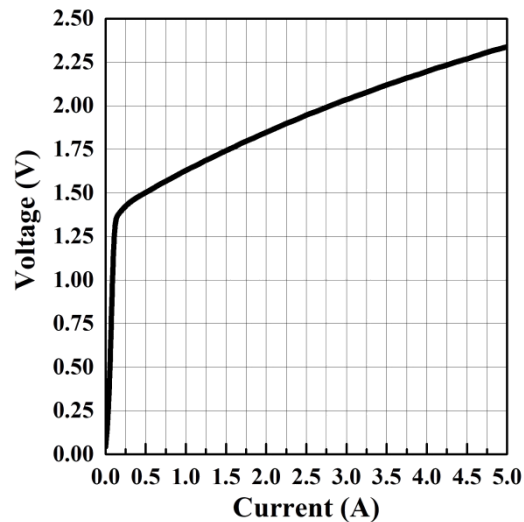
Tolerance: $\pm 0.15\text{mm}$

Figures

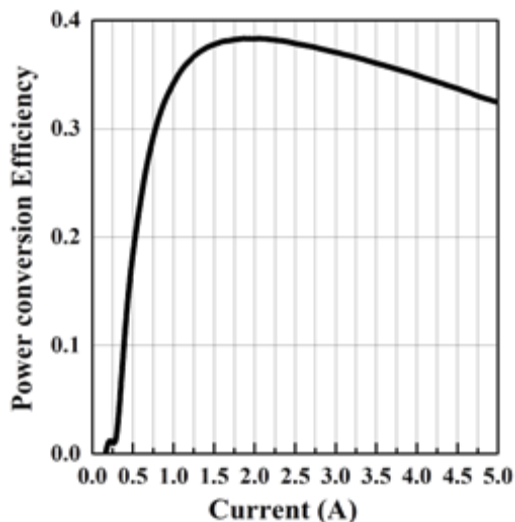
■ Output Power vs. Current



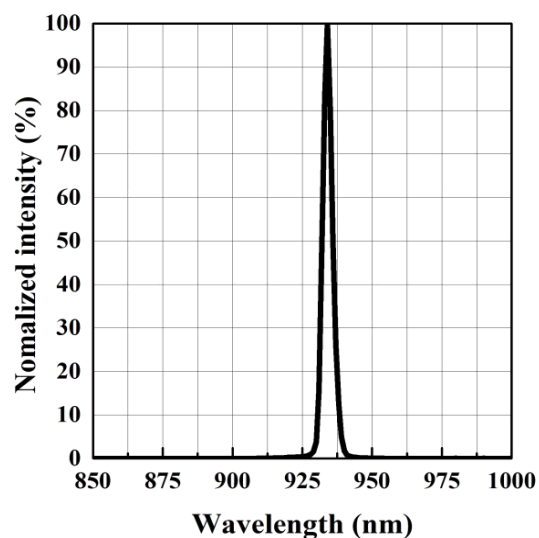
■ Voltage vs. Current



■ Power Conversion Efficiency (PCE)

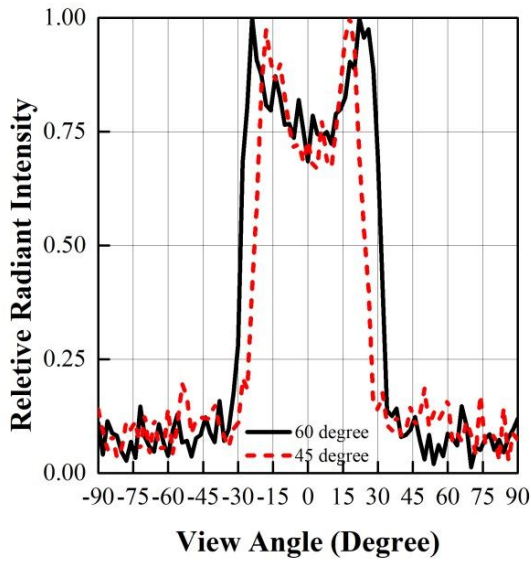


■ Emission Spectrum

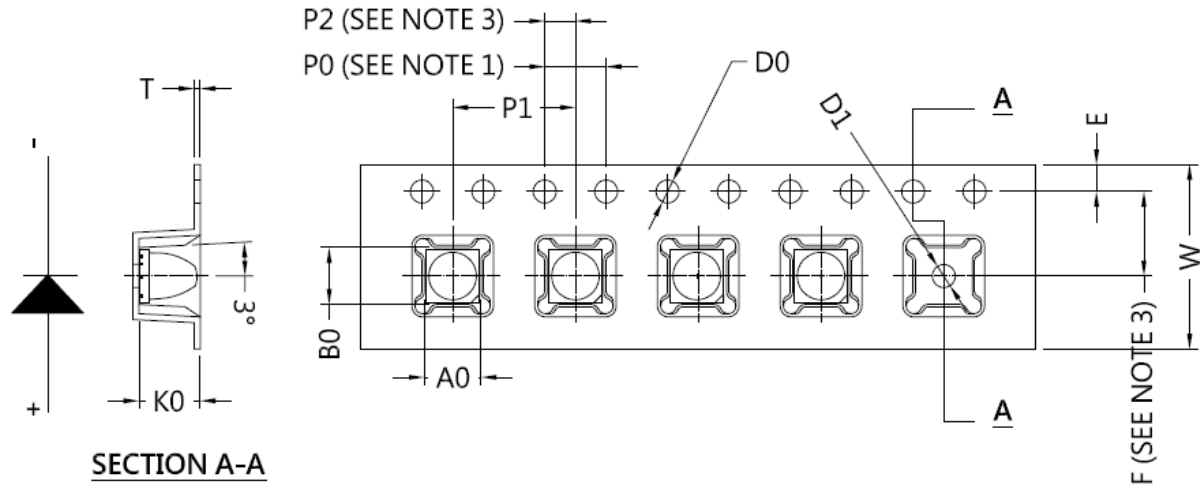


Figures

■ Emitting Angle



Product Packaging Information



Unit: mm

symbol	Ao	Bo	Ko	Po	P1	P2
spec	3.80±0.10	3.80±0.10	2.70±0.10	4.00±0.1	8.00±0.10	2.00±0.1
symbol	E	F	Do	D1	W	T
spec	1.75±0.10	5.50±0.1	1.50±0.10	1.50±0.10	12.0±0.30	0.30±0.05

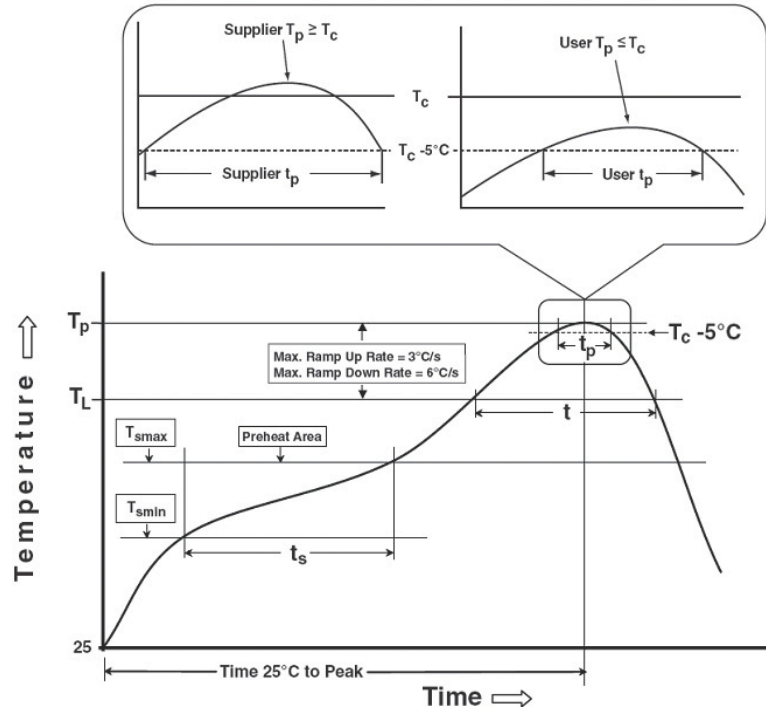
Note:

1. 10 sprocket hole pitch cumulative tolerance ± 0.2
2. Camber in compliance with EIA 481
3. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.

Item	Quantity	Total	Dimensions(mm)
Reel	600pcs	600pcs	R-178
Box	4 Reels	2,400pcs	245×240×70
Carton	7 boxes	16,800pcs	520×285×255
Starting with 50 pcs empty, and 50 pcs empty at the last.			

Reflow Profile

The following reflow profile is from IPC/JEDECJ-STD-020D which provided here for reference.



Profile Feature	Pb-Free Assembly
Preheat & Soak	150°C
Temperature min (T_{smin}) Temperature max (T_{smax}) Time (T_{smin} to T_{smax}) (t_s)	200°C 90-120 seconds
Average ramp-up rate (T_{smax} to T_p)	$3^\circ\text{C/second max.}$
Liquidous temperature (T_L) Time at liquidous (t_l)	220°C 35-70 seconds
Peak package body temperature (T_p)	$240^\circ\text{C} \sim 245^\circ\text{C}$
Classification temperature (T_c)	240°C
Average ramp-down rate (T_p to T_{smax})	$6^\circ\text{C/second max.}$
Time 25°C to peak temperature	8 minutes max.